**Product data sheet** 

# 1. General description

Ultrafast power diode in a SMC package.

#### 2. Features and benefits

- Fast switching
- SMC package
- · High voltage capability
- Low forward voltage drop
- Low leakage current
- · Low thermal resistance
- · Soft recovery characteristic

## 3. Applications

- Discontinuous Current Mode (DCM) Power Factor Correction (PFC)
- High frequency switched-mode power supplies

#### 4. Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter	Conditions		Values			Unit	
Absolute maximum rating								
$V_{RRM}$	repetitive peak reverse voltage		600				V	
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; square-wave pulse; $T_{lead} \le 96$ °C; Fig. 1; Fig. 2; Fig. 3	5			А		
I <sub>FRM</sub>	repetitive peak forward current	$\delta$ = 0.5 ; $t_p$ = 25 $\mu$ s; $T_{lead} \le$ 96 °C; square-wave pulse	10			А		
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	130			А		
		$t_p$ = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	143			Α		
Symbol	Parameter	Conditions	Min Typ Max		Max	Unit		
Static ch	aracteristics							
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 5 A; T <sub>j</sub> = 25 °C		-	1.10	1.35	V	
		I <sub>F</sub> = 5 A; T <sub>j</sub> = 150 °C	- 0.9 1.15		V			
Dynamic characteristics								
t <sub>rr</sub>	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A/us};$ $T_j = 25 \text{ °C}; Fig. 7$		-	45	-	ns	

**Ultrafast power diode** 

**MUR560** 

# 5. Pinning information

#### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode		× 14 .
2	A	anode	1 2	K — A 001aaa020

# 6. Ordering information

#### **Table 3. Ordering information**

Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
MUR560	SMC	MUR560J	Reel	3000	SMCS	16-Aug-2017

# 7. Marking

#### Table 4. Marking codes

Type number	Marking codes
MUR560	560JS

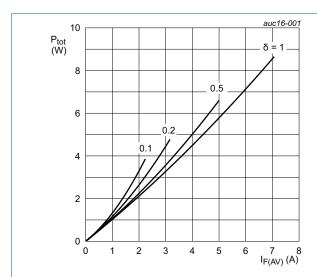
Ultrafast power diode

## 8. Limiting values

#### **Table 5. Limiting values**

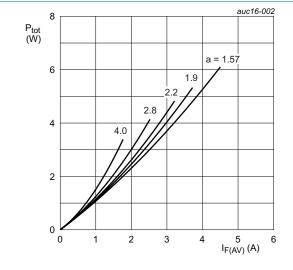
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
$V_{RRM}$	repetitive peak reverse voltage		600	V
$V_{\text{RWM}}$	crest working reverse voltage		600	V
$V_R$	reverse voltage	DC	600	V
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; square-wave pulse; $T_{lead} \le 96$ °C; Fig. 1; Fig. 2; Fig. 3	5	Α
I <sub>FRM</sub>	repetitive peak forward current	$\delta$ = 0.5 ; t <sub>p</sub> = 25 μs; T <sub>lead</sub> ≤ 96 °C; square-wave pulse	10	Α
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	130	Α
		$t_p$ = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	143	Α
T <sub>stg</sub>	storage temperature		-65 to 175	°C
T <sub>j</sub>	junction temperature		175	°C



 $I_{F(AV)} = I_{F(RMS)} \times \sqrt{\delta}$ V<sub>o</sub> = 0.992 V; R<sub>s</sub> = 0.0327 \Omega

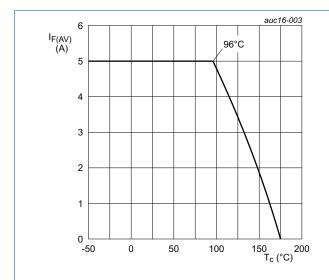
Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values

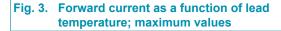


a = form factor =  $I_{F(RMS)}/I_{F(AV)}$  $V_o$  = 0.992 V;  $R_s$  = 0.0327  $\Omega$ 

Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values

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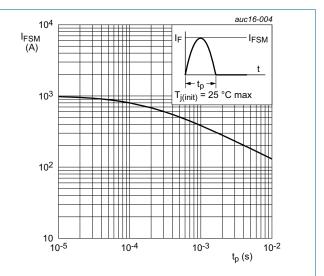


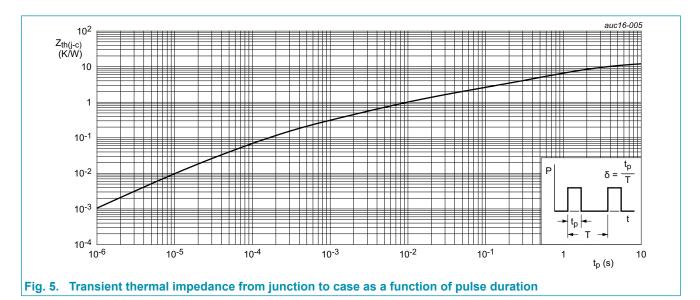
Fig. 4. Non-repetitive peak forward current as a function of pulse width; sinusoidal waveform; maximum values

Ultrafast power diode

### 9. Thermal characteristics

**Table 6. Thermal characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-c)</sub>	thermal resistance from junction to case	mounted on a minimum footprint printed-circuit board (FR4); Fig. 5	-	-	12	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient free air	mounted on a minimum footprint printed-circuit board (FR4)	-	75	-	K/W

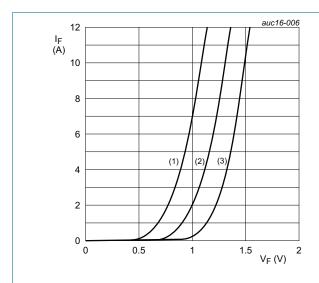


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### 10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static ch	aracteristics					
$V_{F}$	forward voltage	I <sub>F</sub> = 5 A; T <sub>j</sub> = 25 °C; <u>Fig. 6</u>	-	1.10	1.35	V
		I <sub>F</sub> = 5 A; T <sub>j</sub> = 150 °C; <u>Fig. 6</u>	-	0.9	1.15	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 600 V; T <sub>j</sub> = 25 °C	-	-	3	μA
		V <sub>R</sub> = 600 V; T <sub>j</sub> = 150 °C	-	-	250	μA
Dynamic	characteristics					
Q <sub>r</sub>	reverse charge	$I_F = 5 \text{ A}$ ; $V_R = 400 \text{ V}$ ; $dI_F/dt = 100 \text{ A/us}$ ; $T_j = 25 \text{ °C}$ ; Fig. 7	-	216	-	nC
		$I_F = 5 \text{ A}$ ; $V_R = 400 \text{ V}$ ; $dI_F/dt = 100 \text{ A/us}$ ; $T_j = 125 \text{ °C}$ ; Fig. 7	-	420	-	nC
t <sub>rr</sub>	reverse recovery time	$I_F = 1 \text{ A}$ ; $V_R = 30 \text{ V}$ ; $dI_F/dt = 50 \text{ A/us}$ ; $T_j = 25 \text{ °C}$ ; Fig. 7	-	45	-	ns
		$I_F = 0.5 \text{ A}$ ; $I_R = 1 \text{ A}$ ; $I_{R(meas)} = 0.25 \text{ A}$ ; $T_j = 25 ^{\circ}\text{C}$ ; Step recovery	-	-	65	ns
		$I_F = 5 \text{ A}$ ; $V_R = 400 \text{ V}$ ; $dI_F/dt = 100 \text{ A/us}$ ; $T_j = 25 ^{\circ}\text{C}$ ; Fig. 7	-	64	-	ns
		$I_F = 5 \text{ A}$ ; $V_R = 400 \text{ V}$ ; $dI_F/dt = 100 \text{ A/us}$ ; $T_j = 125 \text{ °C}$ ; Fig. 7	-	88	-	ns
I <sub>RM</sub>	peak reverse recovery current	$I_F = 5 \text{ A}$ ; $V_R = 400 \text{ V}$ ; $dI_F/dt = 100 \text{ A/us}$ ; $T_j = 25 \text{ °C}$ ; Fig. 7	-	6.7	-	А
		$I_F = 5 \text{ A}$ ; $V_R = 400 \text{ V}$ ; $dI_F/dt = 100 \text{ A/us}$ ; $T_j = 125 \text{ °C}$ ; Fig. 7	-	9.5	-	А
E <sub>as</sub>	non-repetitive avalanche energy	$I_R = 1.2 \text{ A}; T_{j(init)} = 25 \text{ °C}; L = 15 \text{ mH}$	10.8	-	-	mJ



 $V_o$  = 0.992 V;  $R_s$  = 0.0327 Ω (1)  $T_j$  = 150 °C; typical values (2)  $T_j$  = 150 °C; maximum values (3)  $T_i$  = 25 °C; maximum values

Fig. 6. Forward current as a function of forward voltage

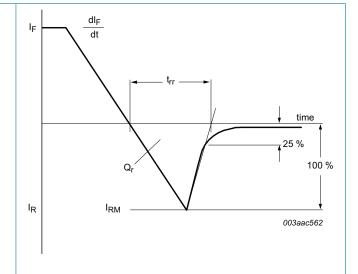


Fig. 7. Reverse recovery definitions; ramp recovery

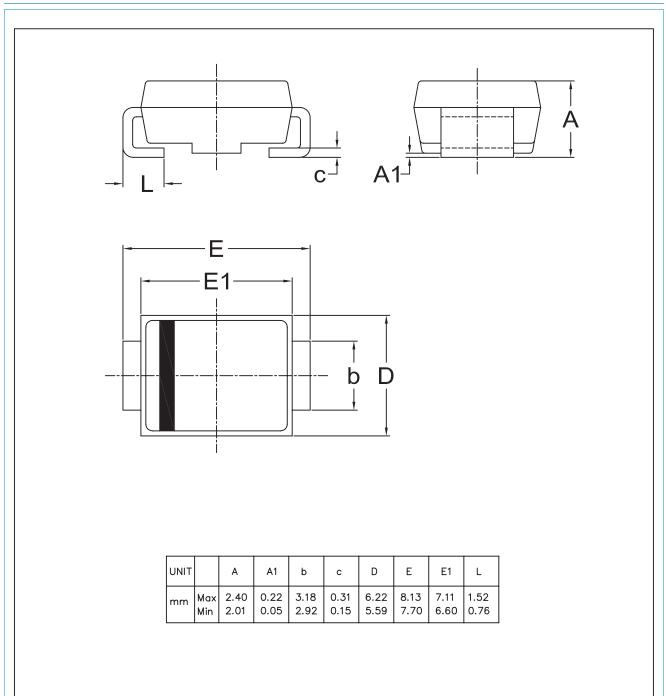
MUR560C

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**Ultrafast power diode** 

# 11. Package outline



Remark: Dimensions D and E1 do not include mold flash.

#### Ultrafast power diode

### 12. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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